

2SK2329(L), 2SK2329(S)

Silicon N-Channel MOS FET

HITACHI

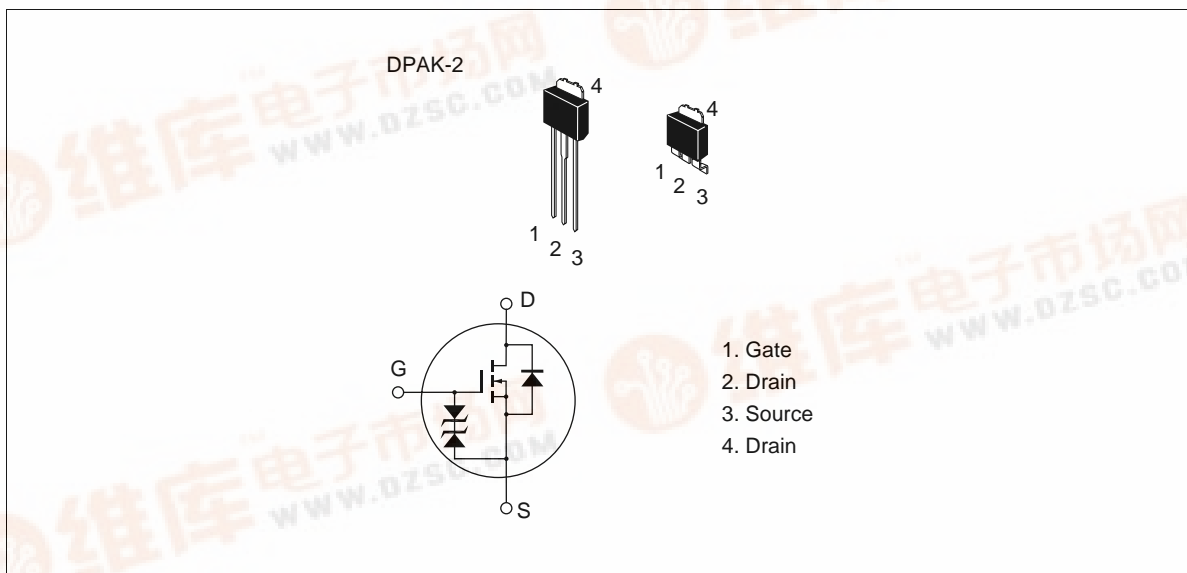
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 2.5 V gate drive device can be driven from 3 V source
- Suitable for Switching regulator, DC-DC converter

Outline



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Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±10	V
Drain current	I _D	10	A
Drain peak current	I _{D(pulse)} ^{*1}	40	A
Body to drain diode reverse drain current	I _{DR}	10	A
Channel dissipation	P _{ch} ^{*2}	20	W
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

- Notes
1. PW ≤ 10 μs, duty cycle ≤ 1 %
 2. Value at Tc = 25 °C

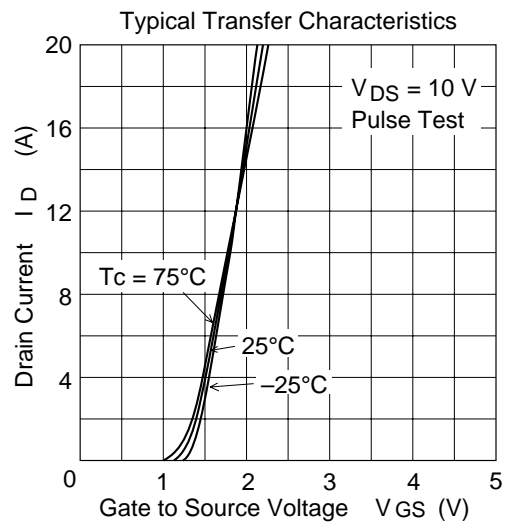
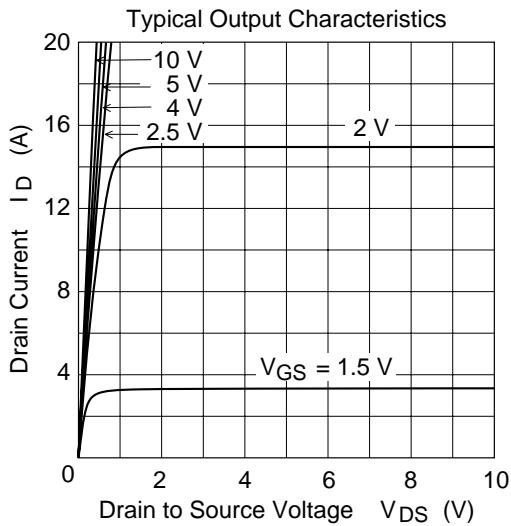
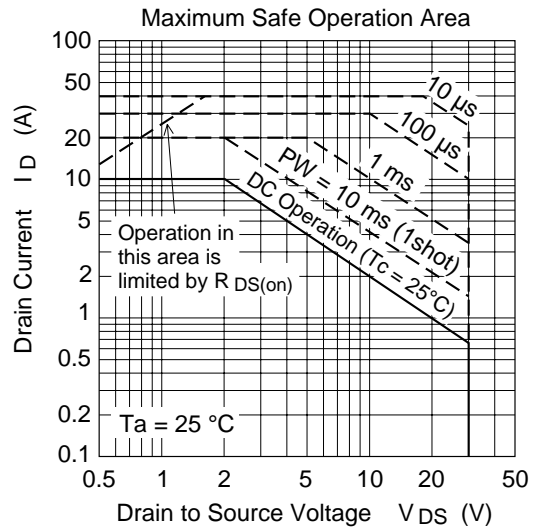
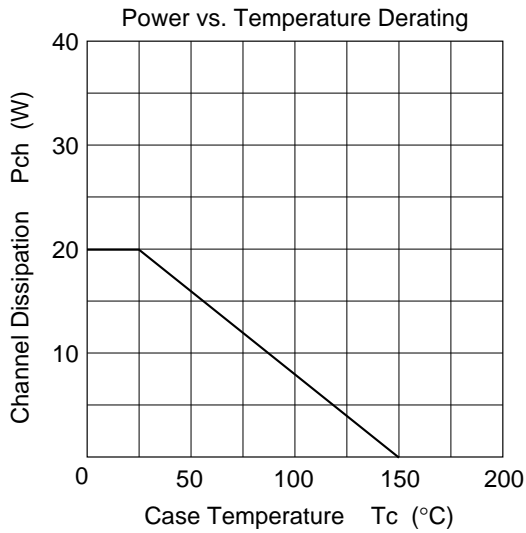
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Electrical Characteristics (Ta = 25°C)

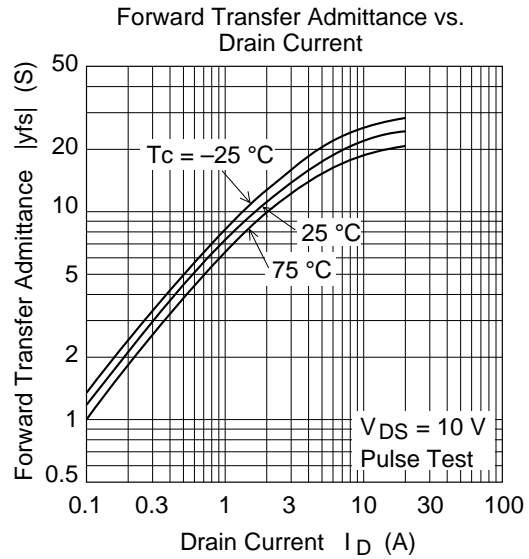
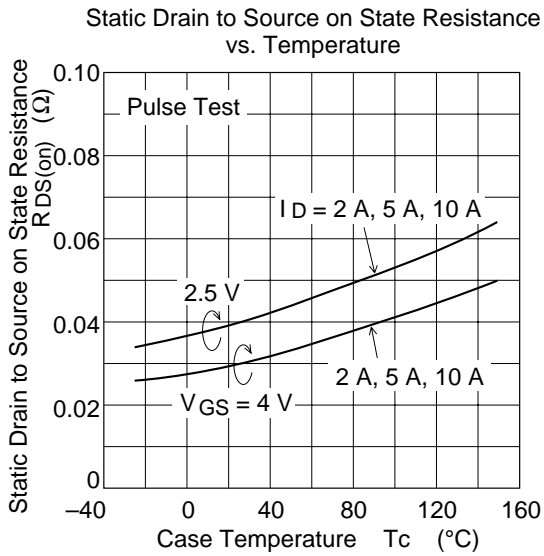
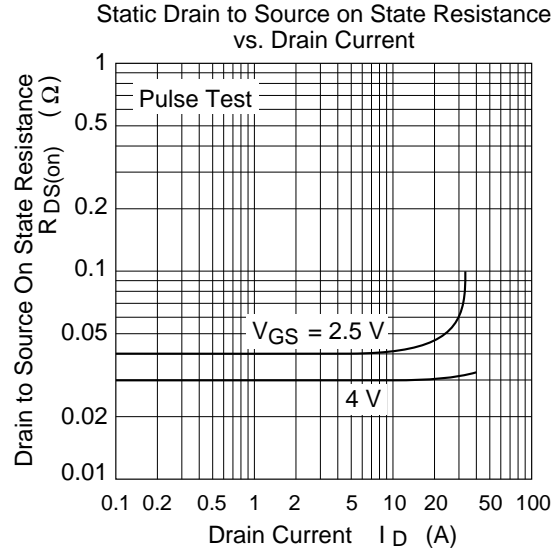
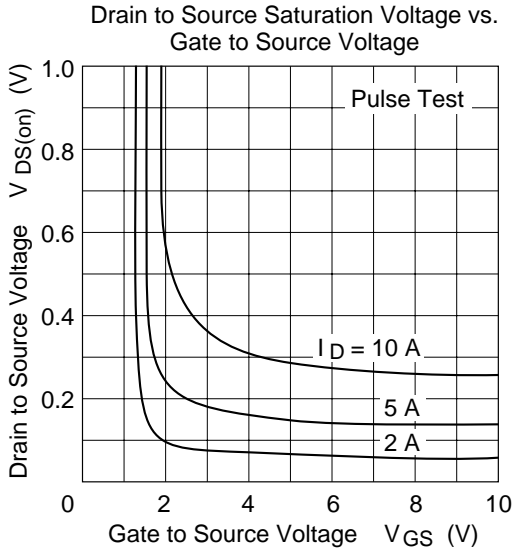
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 10	—	—	V	$I_G = \pm 200 \text{ }\mu\text{A}, V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 6.5 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	100	μA	$V_{DS} = 25 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.4	—	1.4	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.03	0.04	Ω	$I_D = 5 \text{ A}$ $V_{GS} = 4 \text{ V}^{*1}$
		—	0.04	0.06	Ω	$I_D = 5 \text{ A}$ $V_{GS} = 2.5 \text{ V}^{*1}$
Forward transfer admittance	$ y_{fs} $	10	18	—	S	$I_D = 5 \text{ A}$ $V_{DS} = 10 \text{ V}^{*1}$
Input capacitance	C_{iss}	—	1250	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	540	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	120	—	pF	$f = 1 \text{ MHz}$
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	$I_D = 5 \text{ A}$
Rise time	t_r	—	145	—	ns	$V_{GS} = 4 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	225	—	ns	$R_L = 2 \text{ }\Omega$
Fall time	t_f	—	125	—	ns	
Body to drain diode forward voltage	V_{DF}	—	0.9	—	V	$I_F = 10 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	100	—	ns	$I_F = 10 \text{ A}, V_{GS} = 0,$ $di_F / dt = 20 \text{ A} / \mu\text{s}$

Note 1. Pulse Test

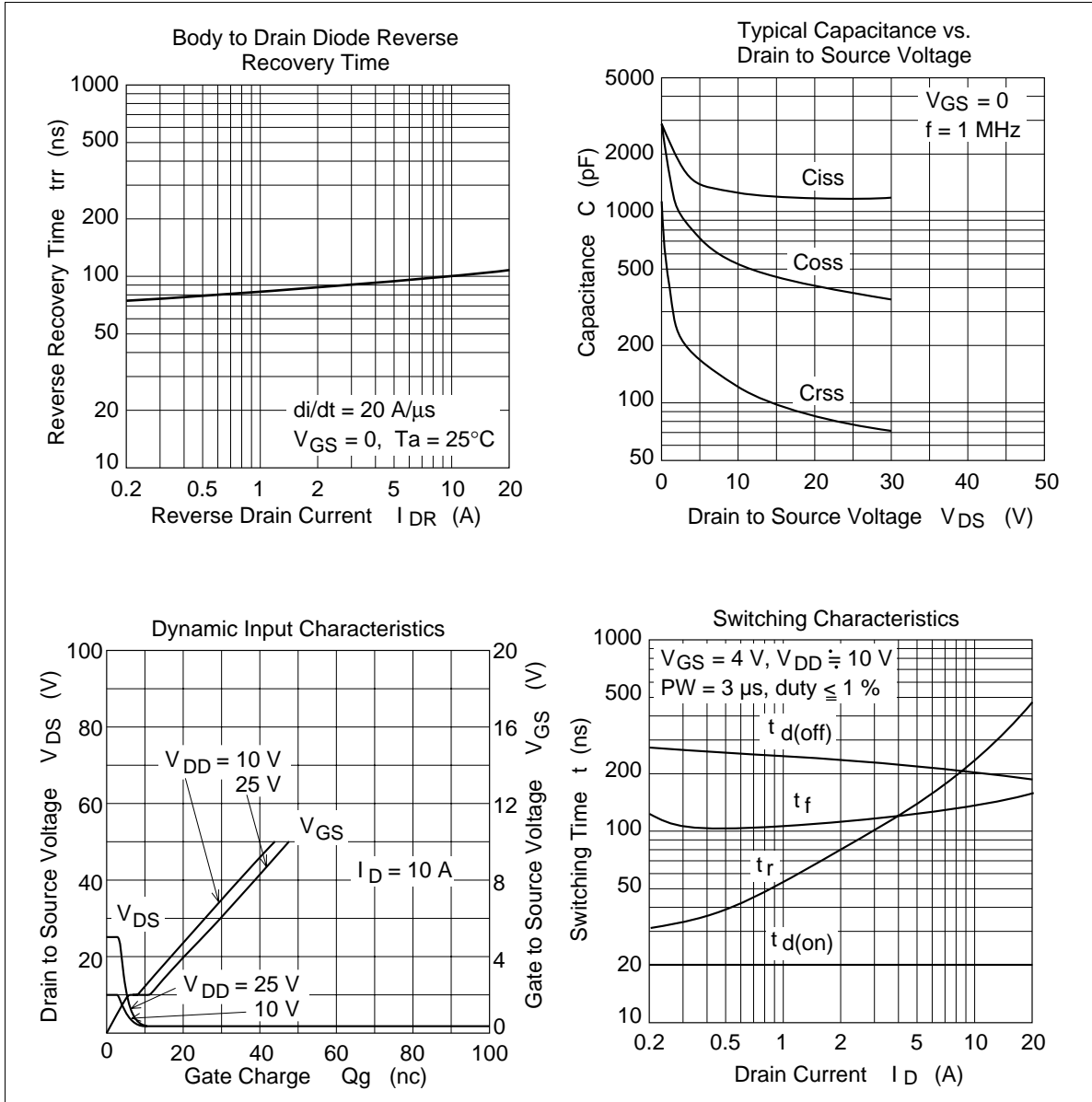
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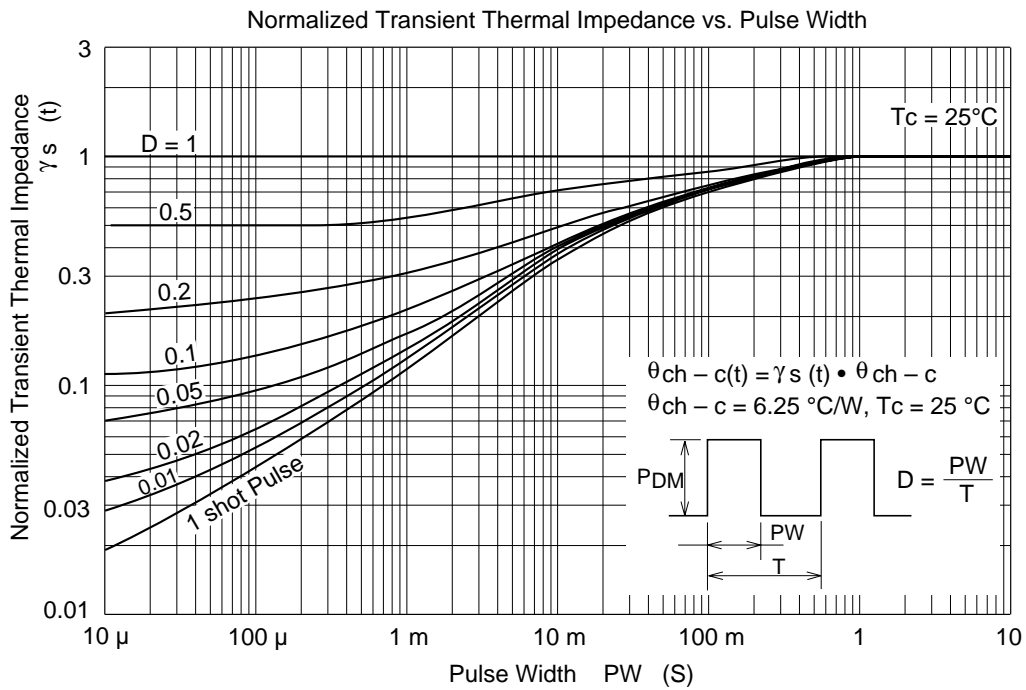
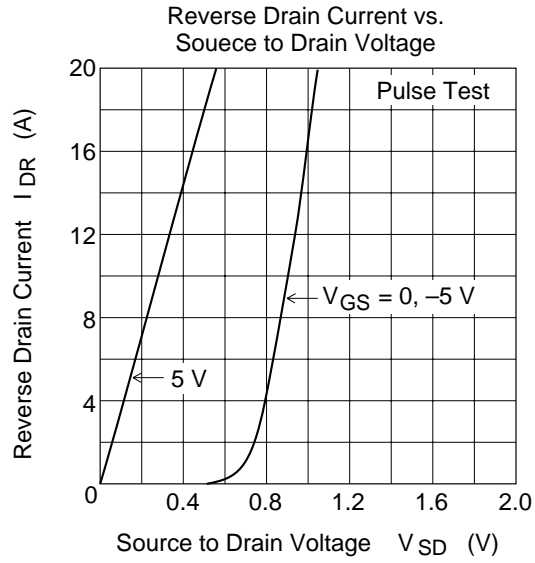


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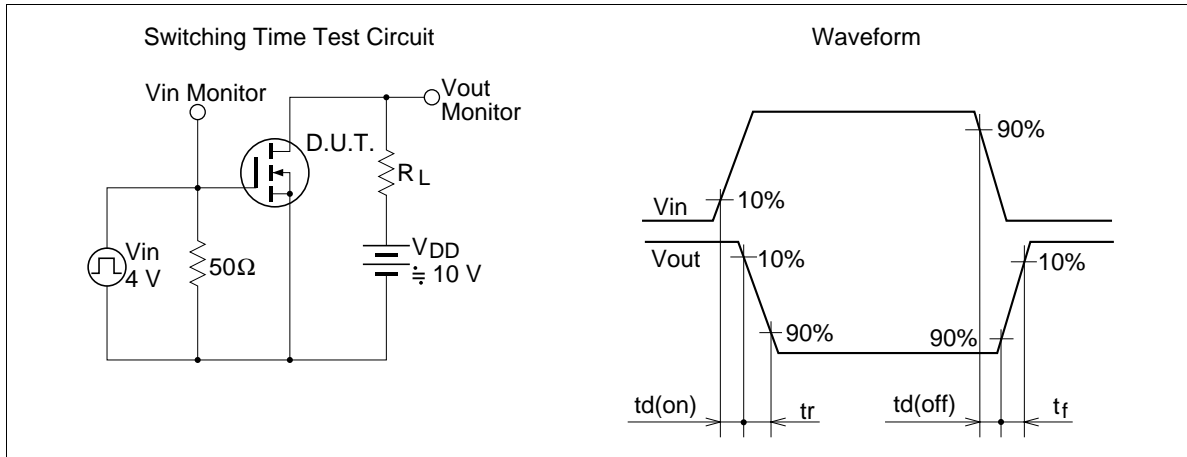


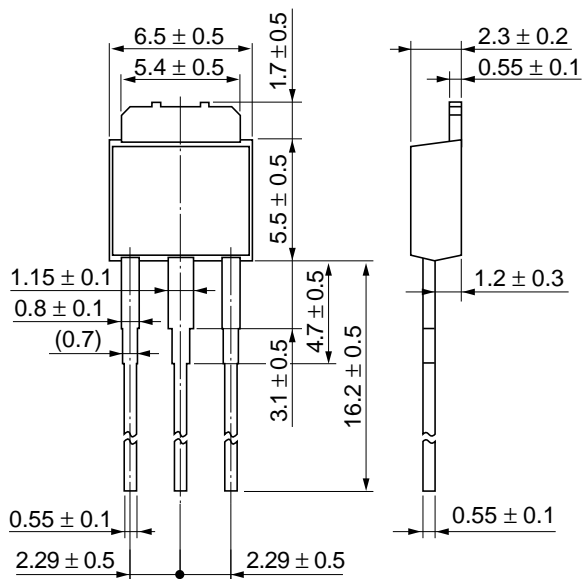
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Unit: mm



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